

NCP6132A, NCP6132B

Dual Output 3 Phase & 2 Phase Controller with Single SVID Interface for Desktop and Notebook CPU Applications

The NCP6132A/NCP6132B dual output three plus two phase buck solution is optimized for Intel IMVP-7 and VR12 compatible CPUs. The controller combines true differential voltage sensing, differential inductor DCR current sensing, input voltage feed-forward, and adaptive voltage positioning to provide accurately regulated power for both Desktop and Notebook applications. The control system is based on Dual-Edge pulse-width modulation (PWM) combined with DCR current sensing providing the fastest initial response to dynamic load events and reduced system cost. It also sheds single phase during light load operation and can auto frequency scale in light load while maintaining excellent transient performance.

There are three internal MOSFET drivers inside the chip. One of these three integrated driver can be configured either to drive core phase or aux phase. NCP6132A and NCP6132B have almost same structure except that NCP6132A has two integrated drivers for the core rail and one integrated driver for auxiliary rail, while the NCP6132B has all three integrated drivers for the core rail.

Features

- Meets Intel's VR12/IMVP7 Specifications
- Three Phase CPU Voltage Regulator, and Two Phase Auxiliary Voltage Regulator, with Three Internal MOSFET Drivers in Total
- Current Mode Dual Edge Modulation for Fastest Initial Response to Transient Loading
- Dual High Performance Operational Error Amplifier
- One Digital Soft Start Ramp for Both Rails
- Dynamic Reference Injection
- Accurate Total Summing Current Amplifier
- DAC with Droop Feed-forward Injection
- Dual High Impedance Differential Voltage and Total Current Sense Amplifiers
- Phase-to-Phase Dynamic Current Balancing
- "Lossless" DCR Current Sensing for Current Balancing
- Summed Thermally Compensated Inductor Current Sensing for Droop
- True Differential Current Balancing Sense Amplifiers for Each Phase
- Switching Frequency Range of 200 kHz – 600 kHz
- Power Saving Phase Shedding
- Start Up into Pre-charged Output Voltage
- Adaptive Voltage Positioning (AVP)
- Vin Feed Forward Ramp Slope
- Pin Programming for Internal SVID Parameters
- Over Voltage Protection (OVP) & Under Voltage Protection (UVP)
- Over Current Protection (OCP)
- Dual Power Good Output with Internal Delays
- Pb-free and Halide-free Packages are Available

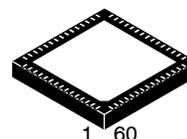
Applications

- Desktop & Notebook Processors



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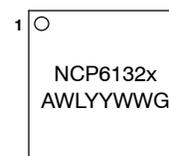
<http://onsemi.com>



QFN60
CASE 485BB

x = A or B
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping† |
|---------------|-----------|-----------|
| NCP6132AMNR2G | QFN60 | 2500/Tape |
| NCP6132BMNR2G | (Pb-Free) | & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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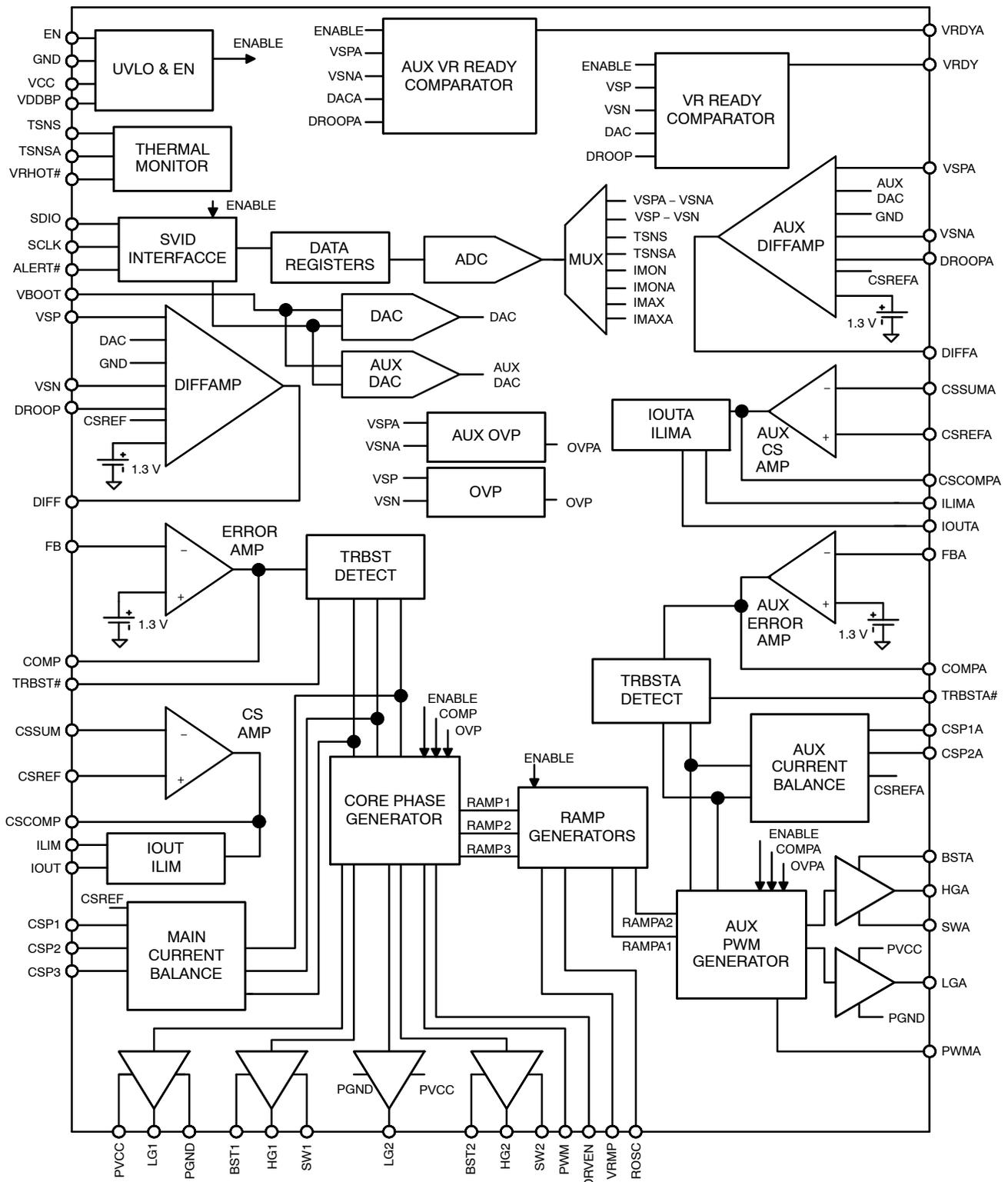


Figure 1. Block Diagram

NCP6132A, NCP6132B

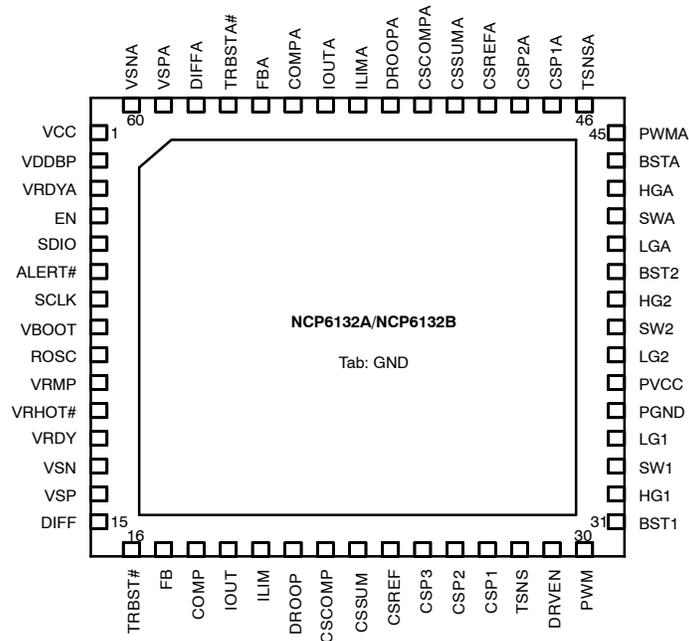


Figure 2. QFN60 Pin Diagram

Table 1. QFN60 PIN LIST DESCRIPTION

| Pin No. | Symbol | Description |
|---------|--------|--|
| 1 | VCC | Power for the internal control circuits. A decoupling capacitor is connected from this pin to ground. |
| 2 | VDDBP | Digital Logic power. Connect this pin to VCC with 10 Ω. Connect 0.1 μF capacitor from this pin to ground |
| 3 | VRDYA | Open drain output. High indicates that the aux output is regulating. |
| 4 | EN | Logic input. Logic high enables both outputs and logic low disables both outputs. |
| 5 | SDIO | Serial VID data interface. |
| 6 | ALERT# | Serial VID ALERT#. |
| 7 | SCLK | Serial VID clock. |
| 8 | VBOOT | A resistor to GND on this pin sets the Core and Aux Boot-up Voltage |
| 9 | ROSC | A resistance from this pin to ground programs the oscillator frequency. This pin supplies a trimmed output voltage of 2 V. |
| 10 | VRMP | Feed-forward input of Vin for the ramp slope compensation. The current fed into this pin is used to control of the ramp of PWM slope |
| 11 | VRHOT# | Thermal logic output for over temperature. |
| 12 | VRDY | Open drain output. High indicates that the core output is regulating. |
| 13 | VSN | Inverting input to the core differential remote sense amplifier. |
| 14 | VSP | Non-inverting input to the core differential remote sense amplifier. |
| 15 | DIFF | Output of the core differential remote sense amplifier. |
| 16 | TRBST# | Compensation pin for the load transient boost. |
| 17 | FB | Error amplifier voltage feedback for core output |
| 18 | COMP | Output of the error amplifier and the inverting inputs of the PWM comparators for the core output. |
| 19 | IOUT | Total output current monitor for core output. Short it to GND if IMON function is not needed. |
| 20 | ILIM | Over current shutdown threshold setting for core output. Resistor to CSCOMP to set threshold. |
| 21 | DROOP | Used to program droop function for core output. It's connected to the resistor divider placed between CSCOMP and CSREF summing node. |
| 22 | CSCOMP | Output of total current sense amplifier for core output. |

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Table 1. QFN60 PIN LIST DESCRIPTION

| Pin No. | Symbol | Description |
|---------|---------|--|
| 23 | CSSUM | Inverting input of total current sense amplifier for core output. |
| 24 | CSREF | Total output current sense amplifier reference voltage input. And inverting input to core current balance sense amplifiers. |
| 25 | CSP3 | Non-inverting input to current balance sense amplifier for phase 3 |
| 26 | CSP2 | Non-inverting input to current balance sense amplifier for phase 2 |
| 27 | CSP1 | Non-inverting input to current balance sense amplifier for phase 1 |
| 28 | TSNS | Temp Sense input for the core converter. |
| 29 | DRVEN | Bidirectional gate driver enable for external drivers for both core and aux rails. It should be left floating if unused. |
| 30 | PWM | Phase 3 PWM output. A resistor to ground on this pin programs IMAX. |
| 31 | BST1 | High-Side Bootstrap supply for phase 1 |
| 32 | HG1 | High-Side gate drive output for phase 1 |
| 33 | SW1 | Current return for high-side gate drive for phase 1 |
| 34 | LG1 | Low-Side gate drive output for phase 1 |
| 35 | PGND | Power ground for gate drivers |
| 36 | PVCC | Power Supply for gate drivers |
| 37 | LG2 | Low-Side gate drive output for phase 2 |
| 38 | SW2 | Current return for high-side gate drive for phase 2 |
| 39 | HG2 | High-Side gate drive output for phase 2 |
| 40 | BST2 | High-Side Bootstrap supply for phase 2 |
| 41 | LGA | Low-Side gate drive output for aux phase 1 |
| 42 | SWA | Current return for high-side gate drive for aux phase 1 |
| 43 | HGA | High-Side gate drive output for aux phase 1 |
| 44 | BSTA | High-Side Bootstrap supply for aux phase 1 |
| 45 | PWMA | Aux Phase 2 PWM output. A resistor to ground on this pin programs IMAXA. |
| 46 | TSNSA | Temp sense for the aux converter |
| 47 | CSP1A | Non-inverting input to aux current balance sense amplifier for phase 1 |
| 48 | CSP2A | Non-inverting input to aux current balance sense amplifier for phase 2 |
| 49 | CSREFA | Total output current sense amplifier reference voltage input for aux. Inverting input to aux current balance sense amplifier for phase 1 and 2 |
| 50 | CSSUMA | Inverting input of total current sense amplifier for aux output |
| 51 | CSCOMPA | Output of total current sense amplifier for aux output |
| 52 | DROOPA | Used to program droop function for aux output. It's connected to the resistor divider placed between CSCOMPA and CSREFA. |
| 53 | ILMA | Over current shutdown threshold setting for aux output. Resistor to CSCOMPA to set threshold. |
| 54 | IOUTA | Total output current monitor for aux output. Short to GND if IMON function is not needed. |
| 55 | COMPA | Output of aux error amplifier and inverting input of PWM comparator for aux output |
| 56 | FBA | Error amplifier voltage feedback for aux output |
| 57 | TRBSTA# | Compensation pin for load transient boost |
| 58 | DIFFA | Output of the aux differential remote sense amplifier |
| 59 | VSPA | Non-inverting input to aux differential remote sense amplifier |
| 60 | VSNA | Inverting input to aux differential remote sense amplifier |
| 61 | GND | Analog ground |

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ABSOLUTE MAXIMUM RATINGS

Table 2. ELECTRICAL INFORMATION

| Pin Symbol | V _{MAX} | V _{MIN} | I _{SOURCE} | I _{SINK} |
|--------------------|--------------------------------|---|---------------------|-------------------|
| COMP, COMPA | V _{CC} + 0.3 V | -0.3 V | 2 mA | 2 mA |
| CSCOMP, CSCOMPA | V _{CC} + 0.3 V | -0.3 V | 2 mA | 2 mA |
| VSN, VSNA | GND + 300 mV | GND - 300 mV | 1 mA | 1 mA |
| DIFF, DIFFA | V _{CC} + 0.3 V | -0.3 V | 2 mA | 2 mA |
| VRDY, VRDYA | V _{CC} + 0.3 V | -0.3 V | N/A | 2 mA |
| VDDPB, VCC, PVCC | 6.5 V | -0.3 V | N/A | N/A |
| ROSC | V _{CC} + 0.3 V | -0.3 V | 1 mA | N/A |
| IOUT, IOUTA Output | TBD | -0.3 V | | |
| VRMP | +25 V | -0.3 V | | |
| SW1, SW2, SWA | 28 V | -5 V -10 V ≤ 200 ns | | |
| BST1, BST2, BSTA | 34 V wrt/ GND 6.5 V wrt/ SW | -0.3 V wrt/ SW | | |
| LG1, LG2, LGA | V _{CC} + 0.3 V | -0.3 V -5 V ≤ 200 ns | | |
| HG1, HG2, HGA | BST + 0.3 V | -0.3 V wrt/ SW -2 V ≤ 200 ns wrt/ SW | | |
| All Other Pins | V _{CC} + 0.3 V | -0.3 V | | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*All signals referenced to GND unless noted otherwise.

Table 3. THERMAL INFORMATION

| Parameters | Symbol | Typical | Units |
|--|------------------|-------------|-------|
| Thermal Characteristic QFN Package (Note 1) | R _{JA} | 31 | °C/W |
| Operating Junction Temperature Range (Note 2) | T _J | -10 to +125 | °C |
| Operating Ambient Temperature Range | | -10 to +100 | °C |
| Maximum Storage Temperature Range | T _{STG} | -40 to +150 | °C |
| Moisture Sensitivity Level QFN Package | MSL | 1 | |

*The maximum package power dissipation must be observed.

1. JESD 51-5 (1S2P Direct-Attach Method) with 0 LFM
2. JESD 51-7 (1S2P Direct-Attach Method) with 0 LFM

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Table 4. NCP6132A/NCP6132B (3+2) ELECTRICAL CHARACTERISTICS

Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|---------------------------------------|--|------------|-----|------------|-------|
| ERROR AMPLIFIER | | | | | |
| Input Bias Current | | -400 | | 400 | nA |
| Open Loop DC Gain | CL = 20 pF to GND, RL = 10 kΩ to GND | | 80 | | dB |
| Open Loop Unity Gain Bandwidth | CL = 20 pF to GND, RL = 10 kΩ to GND | | 55 | | MHz |
| Slew Rate | $\Delta V_{in} = 100\text{ mV}$, $G = -10\text{ V/V}$, $\Delta V_{out} = 1.5\text{ V} - 2.5\text{ V}$, $C_L = 20\text{ pF}$ to GND, DC Load = 10k to GND | | 20 | | V/μs |
| Maximum Output Voltage | $I_{SOURCE} = 2.0\text{ mA}$ | 3.5 | - | - | V |
| Minimum Output Voltage | $I_{SINK} = 2.0\text{ mA}$ | - | - | 1 | V |
| DIFFERENTIAL SUMMING AMPLIFIER | | | | | |
| Input Bias Current | | -400 | - | 400 | nA |
| VSP Input Voltage Range | | -0.3 | - | 3.0 | V |
| VSN Input Voltage Range | | -0.3 | - | 0.3 | V |
| -3 dB Bandwidth | $C_L = 20\text{ pF}$ to GND, $R_L = 10\text{ k}\Omega$ to GND | | 12 | | MHz |
| Closed Loop DC gain VS to DIFF | $VS+ \text{ to } VS- = 0.5 \text{ to } 1.3\text{ V}$ | | 1.0 | | V/V |
| Droop Accuracy | CSREF - DROOP = 80 mV DAC = 0.8 V to 1.2 V -10°C ~ 100°C -10°C ~ 85°C | 78.5 79 | | 81.5 81 | mV |
| Maximum Output Voltage | $I_{SOURCE} = 2\text{ mA}$ | 3.0 | - | - | V |
| Minimum Output Voltage | $I_{SINK} = 2\text{ mA}$ | - | - | 0.5 | V |

3. Guaranteed by design/characterization, not in production test
4. Guaranteed by characterization

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Table 5. ELECTRICAL CHARACTERISTICS Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|--|---|------------|-------------|------------|-------------------------|
| CURRENT SUMMING AMPLIFIER | | | | | |
| Offset Voltage (V_{os}) | | -300 | | 300 | μV |
| Input Bias Current (CSSUM) | CSSUM = CSREF = 1 V | -7.5 | | 7.5 | nA |
| Open Loop Gain | | | 80 | | dB |
| Current Sense Unity Gain Bandwidth | $C_L = 20\ \text{pF to GND}$, $R_L = 10\ \text{k}\Omega\ \text{to GND}$ | | 10 | | MHz |
| Maximum CSCOMP (A) Output Voltage | $I_{source} = 2\ \text{mA}$ | 3.5 | - | - | V |
| Minimum CSCOMP(A) Output Voltage | $I_{sink} = 500\ \mu\text{A}$ | - | - | 0.1 | V |
| CURRENT BALANCE AMPLIFIER | | | | | |
| Input Bias Current | CSPx = CSREF = 1.2 V | -50 | - | 50 | nA |
| Common Mode Input Voltage Range | CSPx = CSREF | 0 | - | 2.0 | V |
| Differential Mode Input Voltage Range | CSREF = 1.2 V | -100 | - | 100 | mV |
| Input Offset Voltage Matching | CSPx = CSREF = 1.2 V, Measured from the average | -1.5 | - | 1.5 | mV |
| Current Sense Amplifier Gain | $0\ \text{V} < \text{CSPx} - \text{CSREF} < 0.1\ \text{V}$, -10°C ~ 85°C -10°C ~ 100°C | 5.7 5.5 | 6.0 6.0 | 6.3 6.3 | V/V |
| Multiphase Current Sense Gain Matching | CSREF = CSP = 10 mV to 30 mV | -3 | | 3 | % |
| -3 dB Bandwidth | | | 8 | | MHz |
| BIAS SUPPLY | | | | | |
| V_{CC} Quiescent Current | EN = high | 20 | 27 | 35 | mA |
| | EN = low | | 10 | 70 | μA |
| UVLO Threshold | V_{CC} rising | | | 4.5 | V |
| | V_{CC} falling | 4.0 | | | V |
| VCC UVLO Hysteresis | | | 200 | | mV |
| VDDBP Quiescent Current | EN = Low EN = High | | 0.8 12.0 | | mA |
| DAC SLEW RATE | | | | | |
| Soft Start Slew Rate | | | 2.33 | | $\text{mV}/\mu\text{s}$ |
| Slew Rate Slow | | | 3.5 | | $\text{mV}/\mu\text{s}$ |
| Slew Rate Fast | | | 13.5 | | $\text{mV}/\mu\text{s}$ |
| AUX Soft Start Slew Rate | | | 2.33 | | $\text{mV}/\mu\text{s}$ |
| AUX Slew Rate Slow | | | 3.5 | | $\text{mV}/\mu\text{s}$ |
| AUX Slew Rate Fast | | | 13.5 | | $\text{mV}/\mu\text{s}$ |
| ENABLE INPUT | | | | | |
| Enable High Input Leakage Current | External 1k pull-up to 3.3 V | - | | 1.0 | μA |
| Upper Threshold | V_{UPPER} | 0.8 | | | V |
| Lower Threshold | V_{LOWER} | | | 0.35 | V |
| Total Hysteresis | $V_{UPPER} - V_{LOWER}$ | | 95 | | mV |
| Enable Delay Time | Measure time from Enable transitioning HI to when DRON goes high, V_{boot} is not 0 V | | | 5.0 | ms |

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NCP6132A, NCP6132B

Table 5. ELECTRICAL CHARACTERISTICS Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|---|---|------------------------|------|------------------------|---------------------|
| DRVEN | | | | | |
| Output High Voltage | Sourcing 500 μA | 3.5 | | | V |
| Output Low Voltage | Sinking 500 μA | | | 0.1 | V |
| Rise Time | CL (PCB) = 20 pF, $\Delta V_o = 10\%$ to 90% | - | 255 | - | ns |
| Fall Time | | - | 2 | - | ns |
| Internal Pull Down Resistance | EN = Low | | 70 | | k Ω |
| IOUT / IOUTA OUTPUT | | | | | |
| Maximum Output Voltage | $R_{lim} = 5\text{k}$ | 2.5 | | | V |
| Input Referred Offset Voltage | I_{limit} to CSREF | -2.5 | | 2.5 | mV |
| Output Source Current | I_{limit} sink current = 80 μA | | | 840 | μA |
| Current Gain | $(I_{OUTCURRENT}) / (I_{LIMCURRENT})$, $R_{ILIM} = R_{OUT} = 8.0\ \text{k}\Omega$, Temp range: 0°C to 60°C | 9.5 | 10 | 10.5 | |
| OSCILLATOR | | | | | |
| Switching Frequency Range | | 200 | - | 800 | kHz |
| Switching Frequency Accuracy | $200\ \text{kHz} < F_{SW} < 800\ \text{kHz}$ | -10 | - | 10 | % |
| 3 Phase Operation | $R_{osc} = 67.4\ \text{k}\Omega$ | 360 | 400 | 440 | kHz |
| Rosc Output Voltage | $R_{osc} = 67.4\ \text{k}\Omega$ | 1.95 | 2.00 | 2.05 | V |
| OUTPUT OVER VOLTAGE & UNDER VOLTAGE PROTECTION (OVP & UVP) | | | | | |
| Over Voltage Threshold During Soft-Start & DVID | | 1.7 | 1.75 | 1.8 | V |
| Over Voltage Threshold Above DAC | VSP(A) Rising | 225 | 250 | 275 | mV |
| Over Voltage Delay | VSP(A) rising to PWMx low | | 50 | | ns |
| Under Voltage Threshold Below DAC-DROOP | VSP(A) Falling | 350 | 400 | 450 | mV |
| Under-voltage Hysteresis | VSP(A) Rising | | 25 | | mV |
| Under-voltage Delay | | | 5 | | μs |
| VR12 DAC | | | | | |
| System Voltage Accuracy | $-10^{\circ}\text{C} \sim 85^{\circ}\text{C}$ $1.0\ \text{V} \leq \text{DAC} < 1.52\ \text{V}$ $0.8\ \text{V} < \text{DAC} < 0.995\ \text{V}$ $0.5\ \text{V} < \text{DAC} < 0.795\ \text{V}$ $0.25\ \text{V} < \text{DAC} < 0.495\ \text{V}$ $-10^{\circ}\text{C} \sim 100^{\circ}\text{C}$ $1.0\ \text{V} \leq \text{DAC} < 1.52\ \text{V}$ $0.8\ \text{V} < \text{DAC} < 0.995\ \text{V}$ $0.5\ \text{V} < \text{DAC} < 0.795\ \text{V}$ $0.25\ \text{V} < \text{DAC} < 0.495\ \text{V}$ | -0.5 -5 -8 -8 | | +0.5 +5 +8 +8 | % mV mV mV |
| Droop Feed-Forward Current | Measure on DROOP pin | 60 | 66 | 72 | μA |
| Droop Feed-Forward Pulse On-Time | | | 0.16 | | μs |
| OVERCURRENT PROTECTION | | | | | |
| ILIM Threshold Current (OCP shutdown after 50 μs delay) | Aux/Core Multiphase, PS0, $R_{lim} = 20\ \text{k}\Omega$ | 9.0 | 10 | 11.0 | μA |
| | Aux/Core 1-phase, PS1/2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 10 | | μA |
| | Aux 2-phase, PS1, $R_{lim} = 20\ \text{k}\Omega$ | | 10 | | μA |
| | Core 2-phase, PS1, $R_{lim} = 20\ \text{k}\Omega$ | | 6.5 | | μA |
| | Aux/Core 2-phase, PS2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 6.5 | | μA |
| | Core 3-phase, PS1/2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 4.0 | | μA |

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4. Guaranteed by characterization

NCP6132A, NCP6132B

Table 5. ELECTRICAL CHARACTERISTICS Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|--|--|------|------|------|---------------|
| OVERCURRENT PROTECTION | | | | | |
| ILIM Threshold Current (immediate OCP shutdown) | Aux/Core Multiphase, PS0, $R_{lim} = 20\ \text{k}\Omega$ | 13.5 | 15 | 16.5 | μA |
| | Aux/Core 1-phase, PS1/2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 15 | | μA |
| | Aux 2-phase, PS1, $R_{lim} = 20\ \text{k}\Omega$ | | 15 | | μA |
| | Core 2-phase, PS1, $R_{lim} = 20\ \text{k}\Omega$ | | 10 | | μA |
| | Aux/Core 2-phase, PS2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 10 | | μA |
| | Core 3-phase, PS1/2/3, $R_{lim} = 20\ \text{k}\Omega$ | | 6 | | μA |
| MODULATORS (PWM COMPARATORS) FOR CORE & AUX | | | | | |
| Minimum Pulse Width | $F_{sw} = 350\ \text{kHz}$ | | 60 | | ns |
| 0% Duty Cycle | COMP voltage when the PWM outputs remain LO | | 1.3 | - | V |
| 100% Duty Cycle | COMP voltage when the PWM outputs remain HI $V_{RMP} = 12.0\ \text{V}$ | - | 2.5 | - | V |
| PWM Ramp Duty Cycle Matching | COMP = 2 V, PWM Ton matching | -20 | | 20 | % |
| PWM Phase Angle Error | Between adjacent phases | -25 | | 25 | deg |
| Ramp Feed-forward Voltage range | | 5 | | 22 | V |
| TRBST# | | | | | |
| TRBST/COMP offset | TRBST Starts Sinking Current | | 350 | | mV |
| TRBST Sink Capability | | | 500 | | μA |
| TRBSTA# | | | | | |
| TRBSTA/COMP offset | TRBSTA Starts Sinking Current | | 350 | | mV |
| TRBSTA Sink Capability | | | 500 | | μA |
| VRHOT# | | | | | |
| Output Low Voltage | $I_{VRHOT} = -4\ \text{mA}$ | | | 0.3 | V |
| Output Leakage Current | High Impedance State | -1.0 | - | 1.0 | μA |
| TSNS/TSNSA | | | | | |
| Alert# Assert Threshold | | | 515 | | mV |
| Alert# De-assert Threshold | | | 533 | | mV |
| VRHOT# Assert Threshold | | | 496 | | mV |
| VRHOT# Rising Threshold | | | 515 | | mV |
| TSNS Bias Current | | 115 | 120 | 125 | μA |
| ADC | | | | | |
| Voltage Range | | 0 | | 2 | V |
| Total Unadjusted Error (TUE) | | -1 | | +1 | % |
| Differential Nonlinearity (DNL) | 8-bit | | | 1 | LSB |
| Power Supply Sensitivity | | | +/-1 | | % |
| Conversion Time | | | 30 | | μs |
| Round Robin | | | 90 | | μs |
| VRDY, VRDYA (Power Good) OUTPUT | | | | | |
| Output Low Saturation Voltage | $I_{VRDY(A)} = 4\ \text{mA}$ | - | - | 0.3 | V |

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4. Guaranteed by characterization

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Table 5. ELECTRICAL CHARACTERISTICS Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|--|---|--------------------------|------|------|---------------|
| VRDY, VRDYA (Power Good) OUTPUT | | | | | |
| Rise Time | External pull-up of 1 k Ω to 3.3 V, $C_{TOT} = 45\ \text{pF}$, $\Delta V_o = 10\%$ to 90% | – | 100 | | ns |
| Fall Time | External pull-up of 1 k Ω to 3.3 V, $C_{TOT} = 45\ \text{pF}$, $\Delta V_o = 90\%$ to 10% | | 10 | | ns |
| Output Voltage at Power-up | VRDY, VRDYA pulled up to 5 V via 2 k Ω | – | – | 1.0 | V |
| Output Leakage Current When High | VRDY & VRDYA = 5.0 V | –1.0 | – | 1.0 | μA |
| VRDY Delay (rising) | DAC = TARGET to VRDY | | 500 | | μs |
| VRDY Delay (falling) | From OCP or OVP | – | 5 | – | μs |
| PWM, PWMA OUTPUTS | | | | | |
| Output High Voltage | Sourcing 500 μA | $V_{CC} - 1.0\ \text{V}$ | – | – | V |
| Output Mid Voltage | No Load, SetPS = 02 | 1.3 | 2.0 | 2.7 | V |
| Output Low Voltage | Sinking 500 μA | – | – | 0.7 | V |
| Rise and Fall Time | CL (PCB) = 50 pF, $\Delta V_o = \text{GND to VCC}$ | – | 10 | | ns |
| Tri-State Output Leakage | $G_x = 2.0\ \text{V}$, $x = 1-4$, EN = Low | –1.0 | – | 1.0 | μA |
| PHASE DETECTION | | | | | |
| CSP1A, CSP2A, CSP2, CSP3 Pin Threshold Voltage | | 4.2 | | | V |
| SCLK, SDIO | | | | | |
| V_{IL} | Input Low Voltage | | | 0.45 | V |
| V_{IH} | Input High Voltage | 0.65 | | | V |
| V_{HYS} | Hysteresis Voltage | 50 | | | mV |
| V_{OH} | Output High Voltage | | 1.05 | | V |
| R_{ON} | Buffer On Resistance (data line, ALERT#, and VRHOT#) | 4 | | 13 | Ω |
| Leakage Current | | –100 | | 100 | μA |
| Pad Capacitance (Note 3) | | | | 4.0 | pF |
| VR clock to data delay (T_{co}) (Note 3) | | 4 | | 8.3 | ns |
| Setup time (T_{su}) (Note 3) | | 7 | | | ns |
| Hold time (T_{hd}) (Note 3) | | 14 | | | ns |
| HIGH-SIDE MOSFET DRIVER | | | | | |
| Pull-up Resistance, Sourcing Current (Note 4) | BST = PVCC | | 1.2 | 2.0 | Ω |
| High Side Driver Sourcing Current | BST = PVCC | | 4.17 | | A |
| Pull-down Resistance, Sinking Current (Note 4) | BST = PVCC | | 0.8 | 2.0 | Ω |
| High Side Driver Sinking Current | BST = PVCC | | 6.25 | | A |
| HG1, HG2, HGA Rise Time | $V_{CC} = 5\ \text{V}$, 3 nF load, BST – SW = 5 V | 6 | 16 | 30 | ns |
| HG1, HG2, HGA Fall Time | $V_{CC} = 5\ \text{V}$, 3 nF load, BST – SW = 5 V | 6 | 11 | 30 | ns |
| HG1, HG2, HGA Turn-On Propagation Delay $t_{pdHDRVH}$ | $C_{LOAD} = 3\ \text{nF}$ | 16 | 40 | 47 | ns |
| SW1, SW2, SWA Pull-Down Resistance | SW to PGND | | 2 | | k Ω |
| HG1, HG2, HGA Pull-Down Resistance | HG to SWBST–SW = 0 V | | 260 | | k Ω |

3. Guaranteed by design/characterization, not in production test

4. Guaranteed by characterization

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Table 5. ELECTRICAL CHARACTERISTICS Unless otherwise stated: $-10^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$; $V_{CC} = 5.0\text{ V}$; $C_{VCC} = 0.1\ \mu\text{F}$

| Parameter | Test Conditions | Min | Typ | Max | Units |
|--|---|-----|------------|------|------------------|
| HIGH-SIDE MOSFET DRIVER | | | | | |
| BST Quiescent Current | EN = L (shutdown) EN = H, no switching | | 1.0 300 | 10 | μA |
| LOW-SIDE MOSFET DRIVER | | | | | |
| Pull-up Resistance, Sourcing Current (Note 4) | | | 0.9 | 2.0 | Ω |
| Low Side Driver Sourcing Current | | | 5.56 | | A |
| Pull-down Resistance, Sinking Current (Note 4) | | | 0.4 | 1.0 | Ω |
| Low Side Driver Sinking Current | | | 12.5 | | A |
| LG1, LG2, LGA Rise Time | 3 nF load | 6 | 16 | 30 | ns |
| LG1, LG2, LGA Fall Time | 3 nF load | 6 | 11 | 30 | ns |
| LG1, LG2, LGA Turn-On Propagation Delay $t_{pdh_{DRVL}}$ | $C_{LOAD} = 3\text{ nF}$ | | 11 | 30 | ns |
| LG1, LG2, LGA Pull-Down Resistance | LG to PGND, $V_{CC} = 5\text{ V}$ | | 45 | | $\text{k}\Omega$ |
| PVCC Quiescent Current | EN = L (Shutdown) EN = H, no switching | | 1.0 490 | 10 | μA |
| BOOTSTRAP RECTIFIER SWITCH | | | | | |
| On Resistance | EN = L or EN = H and DRVL = H | 5.0 | 9.0 | 14.0 | Ω |

- 3. Guaranteed by design/characterization, not in production test
- 4. Guaranteed by characterization

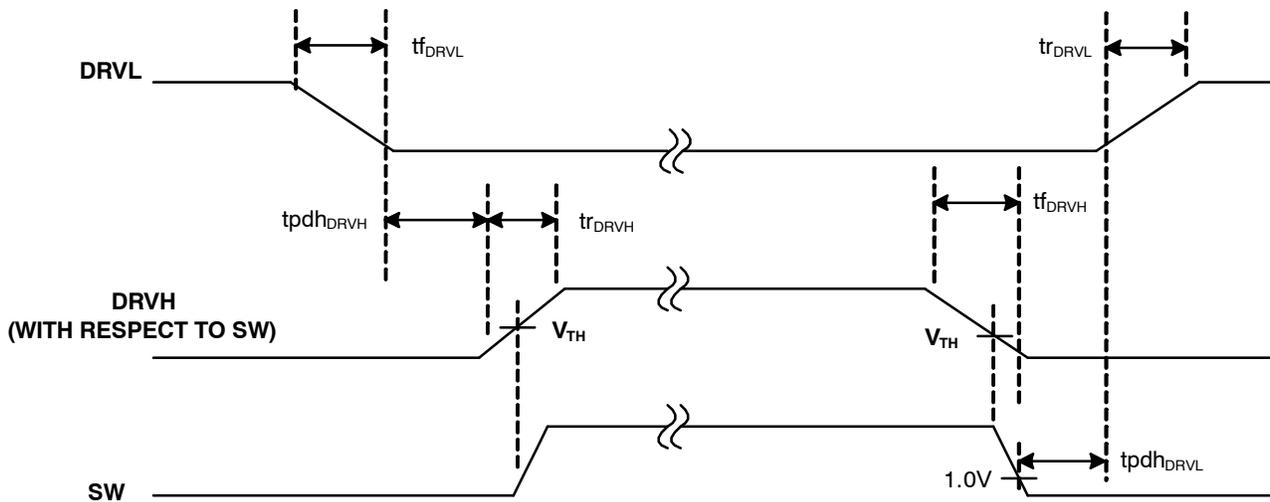


Figure 3. Timing Diagram

NOTE: Timing is referenced to the 90% and 10% points, unless otherwise noted.

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | OFF | 00 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0.25000 | 01 |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0.25500 | 02 |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0.26000 | 03 |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0.26500 | 04 |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0.27000 | 05 |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0.27500 | 06 |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0.28000 | 07 |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0.28500 | 08 |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0.29000 | 09 |
| 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0.29500 | 0A |
| 0 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0.30000 | 0B |
| 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0.30500 | 0C |
| 0 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0.31000 | 0D |
| 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0.31500 | 0E |
| 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0.32000 | 0F |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0.32500 | 10 |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0.33000 | 11 |
| 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0.33500 | 12 |
| 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0.34000 | 13 |
| 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0.34500 | 14 |
| 0 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0.35000 | 15 |
| 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0.35500 | 16 |
| 0 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0.36000 | 17 |
| 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0.36500 | 18 |
| 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0.37000 | 19 |
| 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0.37500 | 1A |
| 0 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0.38000 | 1B |
| 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0.38500 | 1C |
| 0 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 0.39000 | 1D |
| 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0.39500 | 1E |
| 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0.40000 | 1F |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0.40500 | 20 |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0.41000 | 21 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0.41500 | 22 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0.42000 | 23 |
| 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0.42500 | 24 |
| 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 0.43000 | 25 |
| 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0.43500 | 26 |
| 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0.44000 | 27 |
| 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0.44500 | 28 |
| 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0.45000 | 29 |
| 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0.45500 | 2A |

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 0 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0.46000 | 2B |
| 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0.46500 | 2C |
| 0 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0.47000 | 2D |
| 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0.47500 | 2E |
| 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0.48000 | 2F |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0.48500 | 30 |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0.49000 | 31 |
| 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0.49500 | 32 |
| 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0.50000 | 33 |
| 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0.50500 | 34 |
| 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0.51000 | 35 |
| 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0.51500 | 36 |
| 0 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0.52000 | 37 |
| 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0.52500 | 38 |
| 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0.53000 | 39 |
| 0 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0.53500 | 3A |
| 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0.54000 | 3B |
| 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0.54500 | 3C |
| 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0.55000 | 3D |
| 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0.55500 | 3E |
| 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0.56000 | 3F |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0.56500 | 40 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0.57000 | 41 |
| 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0.57500 | 42 |
| 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0.58000 | 43 |
| 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0.58500 | 44 |
| 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0.59000 | 45 |
| 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0.59500 | 46 |
| 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0.60000 | 47 |
| 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0.60500 | 48 |
| 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0.61000 | 49 |
| 0 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0.61500 | 4A |
| 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0.62000 | 4B |
| 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0.62500 | 4C |
| 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0.63000 | 4D |
| 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0.63500 | 4E |
| 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0.64000 | 4F |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0.64500 | 50 |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0.65000 | 51 |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0.65500 | 52 |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0.66000 | 53 |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0.66500 | 54 |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0.67000 | 55 |

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0.67500 | 56 |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0.68000 | 57 |
| 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0.68500 | 58 |
| 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0.69000 | 59 |
| 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0.69500 | 5A |
| 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0.70000 | 5B |
| 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0.70500 | 5C |
| 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0.71000 | 5D |
| 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0.71500 | 5E |
| 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0.72000 | 5F |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0.72500 | 60 |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0.73000 | 61 |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0.73500 | 62 |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0.74000 | 63 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0.74500 | 64 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0.75000 | 65 |
| 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0.75500 | 66 |
| 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0.76000 | 67 |
| 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0.76500 | 68 |
| 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0.77000 | 69 |
| 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 0.77500 | 6A |
| 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0.78000 | 6B |
| 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0.78500 | 6C |
| 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0.79000 | 6D |
| 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 0.79500 | 6E |
| 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 0.80000 | 6F |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0.80500 | 70 |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 0.81000 | 71 |
| 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0.81500 | 72 |
| 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 0.82000 | 73 |
| 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0.82500 | 74 |
| 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 0.83000 | 75 |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0.83500 | 76 |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0.84000 | 77 |
| 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0.84500 | 78 |
| 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0.85000 | 79 |
| 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 0.85500 | 7A |
| 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0.86000 | 7B |
| 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0.86500 | 7C |
| 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0.87000 | 7D |
| 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0.87500 | 7E |
| 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0.88000 | 7F |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0.88500 | 80 |

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0.89000 | 81 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0.89500 | 82 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0.90000 | 83 |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0.90500 | 84 |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0.91000 | 85 |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0.91500 | 86 |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0.92000 | 87 |
| 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0.92500 | 88 |
| 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0.93000 | 89 |
| 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0.93500 | 8A |
| 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0.94000 | 8B |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0.94500 | 8C |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0.95000 | 8D |
| 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0.95500 | 8E |
| 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0.96000 | 8F |
| 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0.96500 | 90 |
| 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0.97000 | 91 |
| 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0.97500 | 92 |
| 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0.98000 | 93 |
| 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0.98500 | 94 |
| 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0.99000 | 95 |
| 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0.99500 | 96 |
| 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1.00000 | 97 |
| 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1.00500 | 98 |
| 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1.01000 | 99 |
| 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1.01500 | 9A |
| 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 1.02000 | 9B |
| 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1.02500 | 9C |
| 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1.03000 | 9D |
| 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1.03500 | 9E |
| 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1.04000 | 9F |
| 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1.04500 | A0 |
| 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1.05000 | A1 |
| 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1.05500 | A2 |
| 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1.06000 | A3 |
| 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1.06500 | A4 |
| 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1.07000 | A5 |
| 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1.07500 | A6 |
| 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1.08000 | A7 |
| 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1.08500 | A8 |
| 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1.09000 | A9 |
| 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1.09500 | AA |
| 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1.10000 | AB |

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1.10500 | AC |
| 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1.11000 | AD |
| 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1.11500 | AE |
| 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1.12000 | AF |
| 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 1.12500 | B0 |
| 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1.13000 | B1 |
| 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1.13500 | B2 |
| 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1.14000 | B3 |
| 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1.14500 | B4 |
| 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1.15000 | B5 |
| 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1.15500 | B6 |
| 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1.16000 | B7 |
| 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1.16500 | B8 |
| 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1.17000 | B9 |
| 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1.17500 | BA |
| 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1.18000 | BB |
| 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1.18500 | BC |
| 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1.19000 | BD |
| 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1.19500 | BE |
| 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1.20000 | BF |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1.20500 | C0 |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1.21000 | C1 |
| 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1.21500 | C2 |
| 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1.22000 | C3 |
| 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1.22500 | C4 |
| 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1.23000 | C5 |
| 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1.23500 | C6 |
| 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1.24000 | C7 |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1.24500 | C8 |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1.25000 | C9 |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1.25500 | CA |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1.26000 | CB |
| 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1.26500 | CC |
| 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1.27000 | CD |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1.27500 | CE |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1.28000 | CF |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1.28500 | D0 |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1.29000 | D1 |
| 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1.29500 | D2 |
| 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1.30000 | D3 |
| 1 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1.30500 | D4 |
| 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1.31000 | D5 |
| 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1.31500 | D6 |

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Table 6. VR12, IMVP-7 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage (V) | HEX |
|------|------|------|------|------|------|------|------|-------------|-----|
| 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1.32000 | D7 |
| 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1.32500 | D8 |
| 1 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1.33000 | D9 |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1.33500 | DA |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1.34000 | DB |
| 1 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1.34500 | DC |
| 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1.35000 | DD |
| 1 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1.35500 | DE |
| 1 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1.36000 | DF |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1.36500 | E0 |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1.37000 | E1 |
| 1 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1.37500 | E2 |
| 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1.38000 | E3 |
| 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1.38500 | E4 |
| 1 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1.39000 | E5 |
| 1 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1.39500 | E6 |
| 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1.40000 | E7 |
| 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1.40500 | E8 |
| 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1.41000 | E9 |
| 1 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1.41500 | EA |
| 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1.42000 | EB |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 1.42500 | EC |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1.43000 | ED |
| 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1.43500 | EE |
| 1 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 1.44000 | EF |
| 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 1.44500 | F0 |
| 1 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1.45000 | F1 |
| 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 1.45500 | F2 |
| 1 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1.46000 | F3 |
| 1 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1.46500 | F4 |
| 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1.47000 | F5 |
| 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1.47500 | F6 |
| 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 1.48000 | F7 |
| 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 1.48500 | F8 |
| 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 1.49000 | F9 |
| 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1.49500 | FA |
| 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1.50000 | FB |
| 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1.50500 | FC |
| 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1.51000 | FD |
| 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1.51500 | FE |
| 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1.52000 | FF |

NCP6132A, NCP6132B

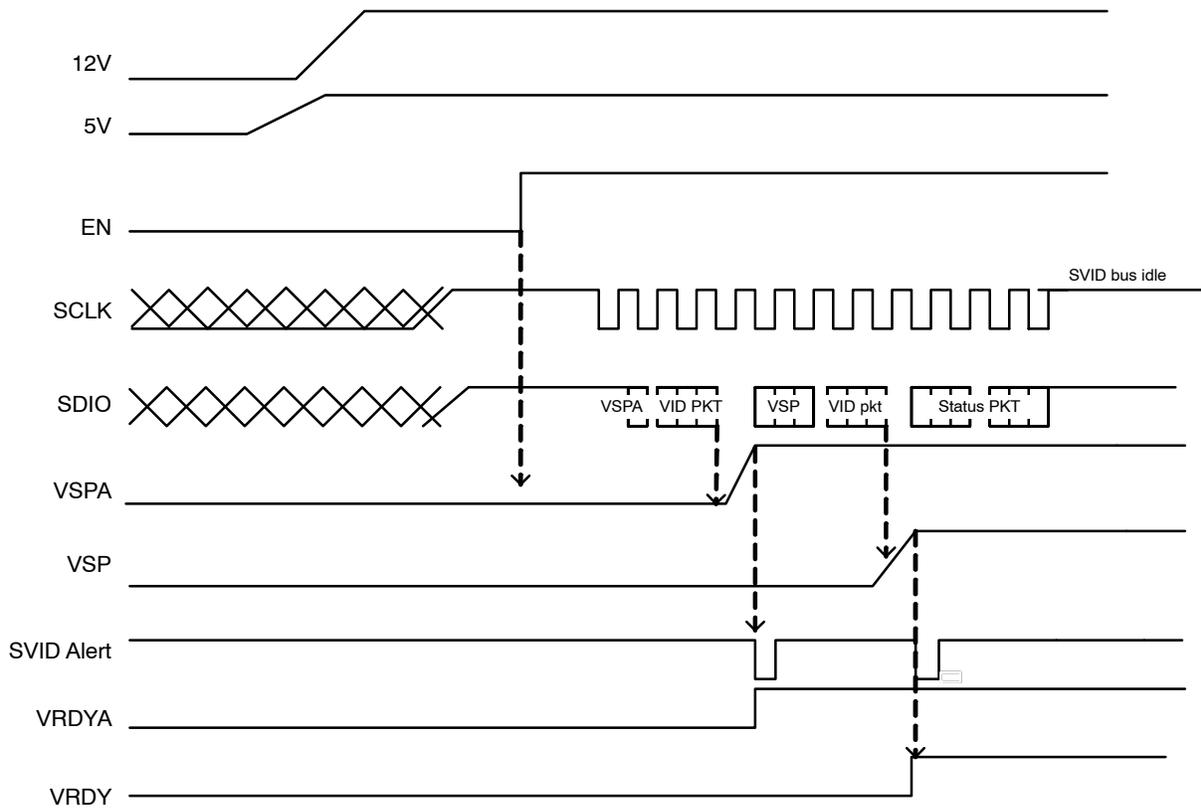


Figure 4. Start Up Timing Diagram

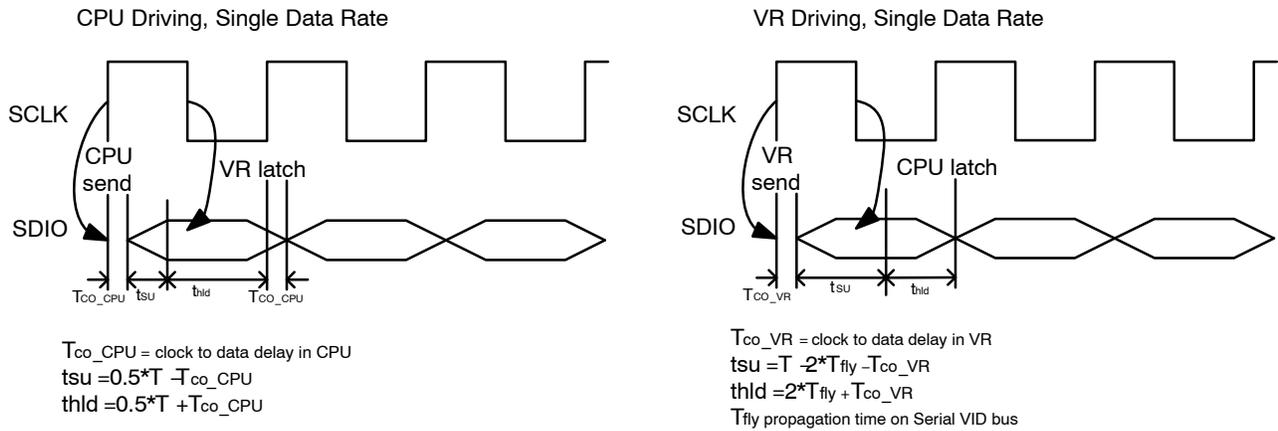


Figure 5. SVID Timing Diagram

NCP6132A, NCP6132B

Table 7. STATE TRUTH TABLE

| STATE | VRDY(A) Pin | Error AMP Comp(A) Pin | OVP(A) & UVP(A) | DRVEN PIN | Method of Reset |
|---|---|-----------------------|-------------------|--|-----------------------------------|
| POR 0 < V _{CC} < UVLO | N/A | N/A | N/A | Resistive pull down | |
| Disabled EN < threshold UVLO > threshold | Low | Low | Disabled | Low | |
| Start up Delay & Calibration EN > threshold UVLO > threshold | Low | Low | Disabled | Low | |
| DRVEN Fault EN > threshold UVLO > threshold DRVEN < threshold | Low | Low | Disabled | Resistive pull up | Driver must release DRVEN to high |
| Soft Start EN > threshold UVLO > threshold DRVEN > High | Low | Operational | Active / No latch | High | |
| Normal Operation EN > threshold UVLO > threshold DRVEN > High | High | Operational | Active / Latching | High | N/A |
| Over Voltage | Low | N/A | DAC + 150 mV | High | |
| Over Current | Low | Operational | Last DAC Code | Low | |
| VID Code = 00h | Follows the MultiVR Config register (34h) Bit 0 setting | Low | Disabled | High, PWM/PWMA outputs in low state LGx outputs in high state | Set Valid VID Code |

NCP6132A, NCP6132B

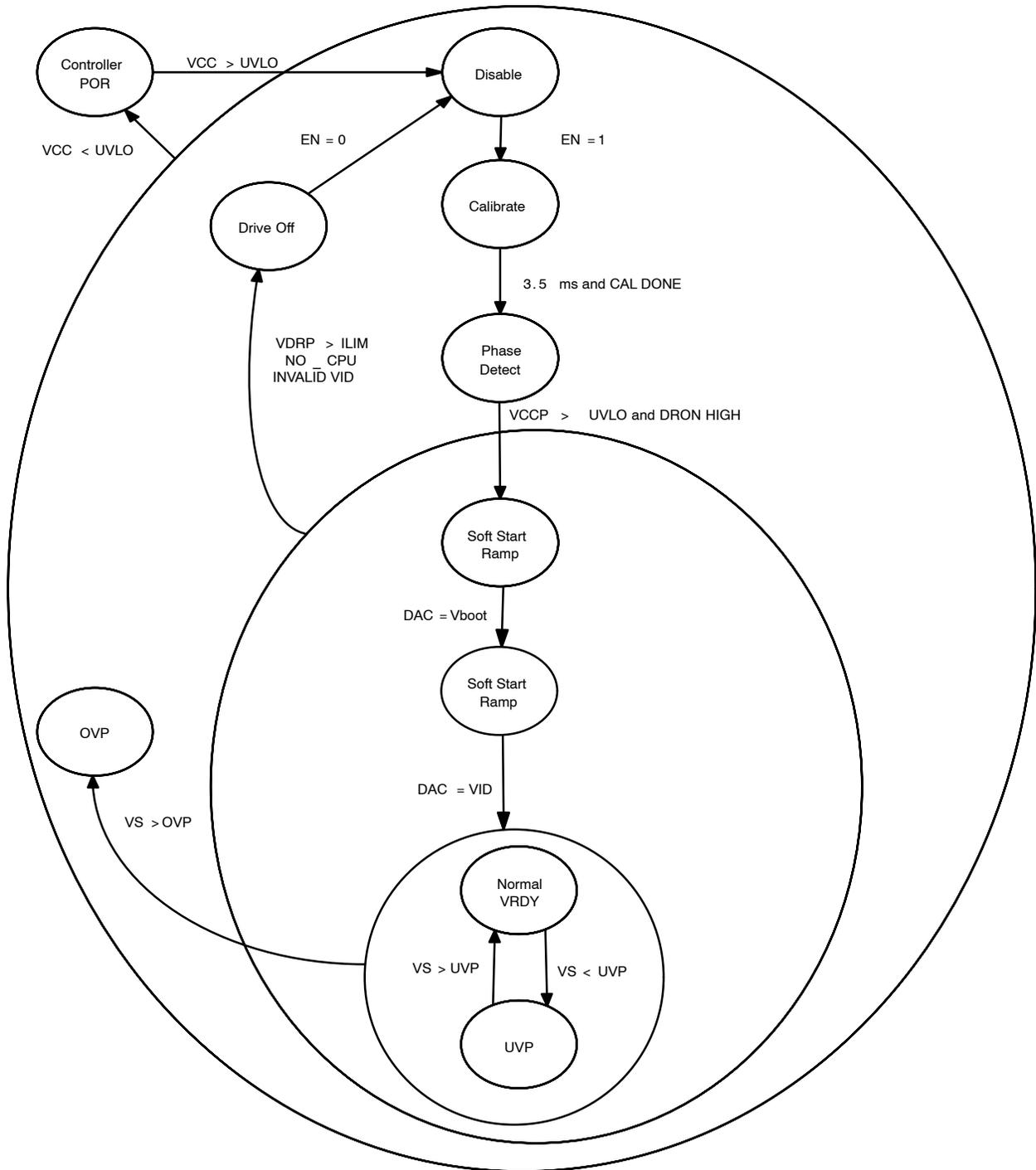


Figure 6. State Diagram

NCP6132A, NCP6132B

General

The NCP6132A/NCP6132B is a dual output three phase plus two phase dual edge modulated multiphase PWM controller designed to meet the Intel VR12 and IMVP-7 specifications with a serial SVID control interface. It is designed to work in notebook, desktop, and server applications.

User-set Phase and Driver Selection

NCP6132A/NCP6132B can be user-configured to operate under different phase and driver combinations. Phase selection for core and aux regulator can be set up separately by configuring the pin connections of CSP2, CSP3, CSP1A, and CSP2A. During start-up (before SVID is available), CSPx pins are monitored to detect user-set

configuration. If a pin is connected to VCC directly or through a low value (1 k Ω) resistor, the monitored input signal is driven to logic high indicating that the corresponding phase is disabled. Otherwise, if a pin is connected normally, the monitored input signal is driven to logic low and that phase is operational. During initialization, the configuration defined by CSPx is written into a User Configuration Register (UCR). If the detected configuration doesn't match any of the valid configurations listed in the table below then it is considered as unsupported. With an unsupported configuration the chip doesn't start switching but remains power-up. After initialization the UCR acts as a Read-Only reg.

The user configuration for core and aux regulator is shown as below:

| No | Core Rail | Aux Rail | CSP2 | CSP3 | CSP1A | CSP2A | PART |
|----|-----------------|-----------------|--------|--------|--------|--------|----------------------|
| 1 | 2 int. + 1 ext. | 1 int. + 1 ext. | normal | normal | Normal | normal | NCP6132A |
| 2 | 2 int. + 1 ext. | 1 int. | normal | normal | Normal | VCC | NCP6132A |
| 3 | 2 int. + 1 ext. | off | normal | normal | VCC | VCC | NCP6132A |
| 4 | 3 int. | 2 ext. | normal | normal | Normal | normal | NCP6132B |
| 5 | 3 int. | 1 ext. | normal | normal | Normal | VCC | NCP6132B |
| 6 | 3 int. | off | normal | normal | VCC | VCC | NCP6132B |
| 7 | 2 int. | 1 int. + 1 ext. | normal | VCC | Normal | normal | NCP6132A |
| 8 | 2 int. | 1 int. | normal | VCC | Normal | VCC | NCP6132A |
| 9 | 2 int. | 2 ext. | normal | VCC | Normal | normal | NCP6132B |
| 10 | 2 int. | 1 ext. | normal | VCC | Normal | VCC | NCP6132B |
| 11 | 2 int. | off | normal | VCC | VCC | VCC | NCP6132A or NCP6132B |
| 12 | 1 int. | 1 int. | VCC | VCC | Normal | VCC | NCP6132A |
| 13 | 1 int. | 1 ext. | VCC | VCC | Normal | VCC | NCP6132B |
| 14 | 1 int. | off | VCC | VCC | VCC | VCC | NCP6132A or NCP6132B |

*NCP6132A supports configurations: 1, 2, 3, 7, 8, 11, 12 and 14; NCP6132B supports configurations: 4, 5, 6, 9, 10, 11, 13, 14.

*When both CSP1A and CSP2A are pulled to V_{CC}, the aux regulator is totally disabled. It does not respond to any SVID command with address 01h.

NCP6132A, NCP6132B

If aux rail is disabled, the unused pins' connection should follow the below table:

UNUSED PIN CONNECTION WITH DISABLED AUX RAIL

| Pin Name | Connect to |
|----------|--------------------------|
| CSP1A | V _{CC} |
| CSP2A | V _{CC} |
| LGA | Float |
| SWA | Float |
| HGA | Float |
| BSTA | Float |
| VSPA | GND |
| VSNA | GND |
| DIFFA | Float |
| FBA | COMPA |
| COMPA | FBA |
| TRBSTA# | Float or V _{CC} |
| CSREFA | GND |
| CSCOMPA | CSSUMA |
| CSSUMA | CSCOMPA |
| DROOPA | CSCOMPA |
| ILIMA | Float |
| TSNSA | GND |
| IOUTA | GND |
| PWMA | Float |

There are three integrated drivers: HG1/LG1, HG2/LG2 and HGA/LGA. There are 5 internal PWM signals: PWM1/2/3 from core controller and PWM1A/2A from aux controller. HG1/LG1 is driven by PWM1, HG2/LG2 is driven by PWM2, and HGA/LGA is driven by PWM1A when aux rail uses one internal driver, driven by PWM3 when core rail uses 3 internal drivers.

To drive the external drivers, NCP6132A/NCP6132B has two PWM signal outputs: PWM and PWMA, whose internal connections depend on the phase and driver configuration. For example, PWM can be driven by PWM3 when there is one external driver needed for core rail, or driven by PWM2A when aux rail requires two external drivers. Similarly, PWMA can be driven either by PWM1A or PWM2A. The detailed phase configuration table is shown below:

PHASE CONFIGURATION TABLE

| | Aux 1 int. + 1 ext. | Aux 2 ext. | Aux 1 int. | Aux 1 ext. | Aux off |
|-------------------------|---|---|---|--|--|
| Core 2 int. + 1 ext. | Core drivers : HG1/LG1 HG2/LG2 PWM Aux drivers : HGA/LGA PWMA | No | Core drivers : HG1/LG1 HG2/LG2 PWM Aux drivers : HGA/LGA | No | Core drivers : HG1/LG1 HG2/LG2 PWM Aux drivers : |
| Core 3 int. | No | Core drivers : HG1/LG1 HG2/LG2 HGA/LGA Aux drivers : PWMA (phase 1) PWM (phase 2) | No | Core drivers : HG1/LG1 HG2/LG2 HGA/LGA Aux drivers : PWMA | Core drivers : HG1/LG1 HG2/LG2 HGA/LGA Aux drivers : |
| Core 2 int. | Core drivers : HG1/LG1 HG2/LG2 Aux drivers : HGA/LGA PWMA | Core drivers : HG1/LG1 HG2/LG2 Aux drivers : PWMA (phase 1) PWM (phase 2) | Core drivers : HG1/LG1 HG2/LG2 Aux drivers : HGA/LGA | Core drivers : HG1/LG1 HG2/LG2 Aux drivers : PWMA | Core drivers : HG1/LG1 HG2/LG2 Aux drivers : |
| Core 1 int. | No | No | Core drivers : HG1/LG1 Aux drivers : HGA/LGA | Core drivers : HG1/LG1 Aux drivers : PWMA | Core drivers : HG1/LG1 Aux drivers : |

NCP6132A, NCP6132B

Phase Interleaving

When both core and graphic rails are in multiphase user configuration, NCP6132A/NCP6132B uses phase interleaved PWM operation for dual output rails, i.e., there's a phase shift between the two rails. The phase shift between core rail and aux rail is to ensure PWM on-cycle of each

interleaved phase has no overlap. It helps reduce the RMS current of the input capacitor connected to V_{in} and therefore lower power dissipation over capacitor ESR.

The interleaved phase angle for different phase configurations is shown in the following diagram.

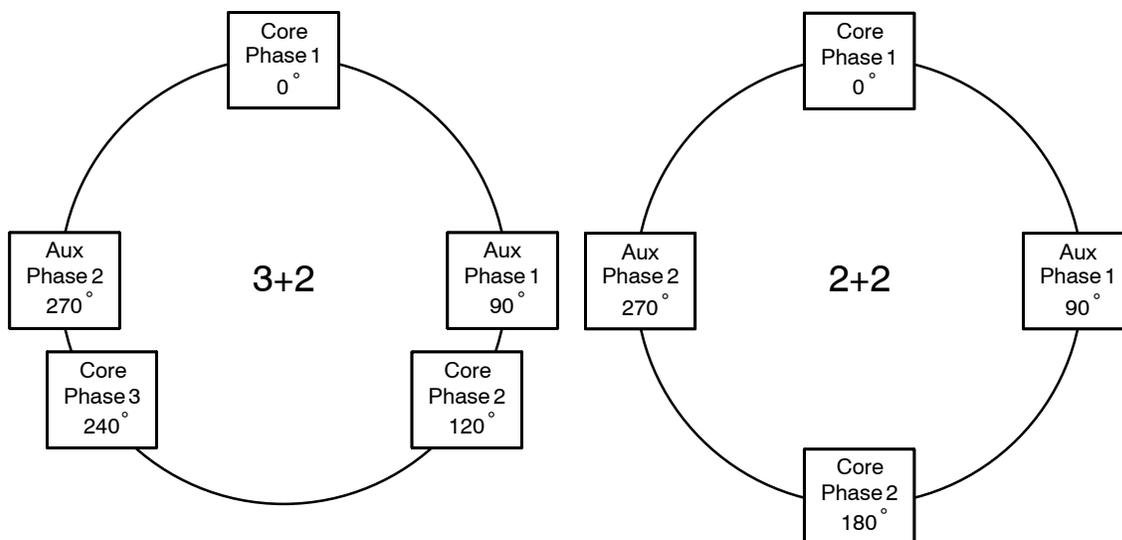


Figure 7. Interleaved Phases Diagram

Phase Shedding (PS)

The NCP6132A/NCP6132B supports phase shedding based by CPU/GPU PSx states. (Auto Phase Shedding triggered by user-set phase shedding threshold without any

PS state transition is not supported.) The NCP6132A/NCP6132B implements PS0, PS1, PS2 and PS3 power saving states for CPU/GPU shown as follows:

For CPU (3-phase or 2-phase user configuration):

| Power Status | | Phases Operating Mode | Control Method |
|--------------|-----------------------|-------------------------------------|----------------|
| PS0 | Heavy load condition | Multi-phase interleaving | CF DEPWM |
| PS1 | Medium load condition | Single-phase Forced CCM mode | QCF RPM |
| PS2/3 | Light load condition | Single-phase Automatic CCM/DCM mode | VF RPM |

For GPU (2-phase user configuration):

| Power Status | | Phases Operating Mode | Control Method |
|--------------|-----------------------|-------------------------------------|----------------|
| PS0 | Heavy load condition | 2-phase interleaving | CF DEPWM |
| PS1 | Medium load condition | 2-phase interleaving | CF DEPWM |
| PS2/3 | Light load condition | Single-phase Automatic CCM/DCM mode | VF RPM |

For CPU & GPU (1-phase user configuration):

| Power Status | | Phases Operating Mode | Control Method |
|--------------|-----------------------|-------------------------------------|----------------|
| PS0 | Heavy load condition | Single-phase Forced CCM mode | QCF RPM |
| PS1 | Medium load condition | Single-phase Forced CCM mode | QCF RPM |
| PS2/3 | Light load condition | Single-phase Automatic CCM/DCM mode | VF RPM |

*CF – Constant Frequency
 DEPWM – Dual Edge Pulse Width Modulation
 QCF – Quasi Constant Frequency
 RPM – Ramp Pulse Modulation
 VF – Variable Frequency

NCP6132A, NCP6132B

In PS2/3 state, transition from CCM to DCM is triggered by a Zero Current Detector (ZCD) latch. ZCD latch is set by a ZCD comparator monitoring switch node (SWN) voltage during PWM off-time. ZCD latch is reset at negative edge of PWM signal and is ready to be set after a set minimum PWM off-time delay. As SWN voltage is stably ramping up toward zero, if the SWN voltage crosses a set (a few negative mV) threshold, then ZCD latch is set and LG1 output is driven to logic low to turn off low-side power switch and phase is operating in DCM. If ZCD latch remains reset during PWM off-cycle, then the low-side power switch remains turned on and the phase is operating in CCM.

If aux phase 1 is configured with external driver, the driver should have built-in ZCD comparator (like NCP5911) to support DCM.

Transition from PS1 to PS0 state triggering phase shedding is called PS1 assertion. Similarly, PS2 assertion is the transition to PS2 state. Note that PS1 assertion in aux rail should be ignored as PS1 and PS0 have the same phase operating mode.

PS1 or PS2 assertion is ignored and user-set multiphase operation is enforced for the following circumstances: during startup, in current limit (CLIMx) operation, and during DVID transition.

Phase shedding is always from multiphase to single phase in one single step.

- For core rail:
 - ◆ Phase shedding from 3-phase is done by driving PWM output (internally connected to PWM3) to mid-level while DRVEN output is still driven to logic high, and by keeping both HG2, LG2 outputs to logic low.
 - ◆ Phase shedding from 2-phase is done by driving both HG2, LG2 outputs to logic low.
- For aux rail:
 - ◆ Phase shedding from 2-phase is done by driving both HGA, LGA outputs to logic low.

Transition from PS1/2/3 to PS0 state triggers phase un-shedding.

Phase un-shedding is instantaneous and happens from single-phase to user-set multiphase configuration in one single step.

Serial VID

The NCP6132A/NCP6132B supports the Intel serial VID interface. It communicates with the microprocessor through three wires (SCLK, SDIO, ALERT#). The table of supported registers is shown below.

| Index | Name | Description | Access | Default |
|-------|------------------|---|--------|---------|
| 00h | Vendor ID | Uniquely identifies the VR vendor. The vendor ID assigned by Intel to ON Semiconductor is 0x1Ah | R | 0x1Ah |
| 01h | Product ID | Uniquely identifies the VR product. The VR vendor assigns this number. | R | 0x00 |
| 02h | Product Revision | Uniquely identifies the revision or stepping of the VR control IC. The VR vendor assigns this data. | R | 0x03 |
| 05h | Protocol ID | Identifies the SVID Protocol the NCP6132A/NCP6132B supports | R | 0x01 |
| 06h | Capability | Informs the Master of the NCP6132A/NCP6132B's Capabilities, 1 = supported, 0 = not supported Bit 7 = I _{out} _format. Bit 7 = 0 when 1A = 1LSB of Reg 15h. Bit 7 = 1 when Reg 15 FFh = I _{cc} _Max. Default = 1 Bit 6 = ADC Measurement of Temp Supported = 1 Bit 5 = ADC Measurement of Pin Supported = 0 Bit 4 = ADC Measurement of V _{in} Supported = 0 Bit 3 = ADC Measurement of I _{in} Supported = 0 Bit 2 = ADC Measurement of P _{out} Supported = 1 Bit 1 = ADC Measurement of V _{out} Supported = 1 Bit 0 = ADC Measurement of I _{out} Supported = 1 | R | 0xC7 |
| 10h | Status_1 | Data register read after the ALERT# signal is asserted. Conveying the status of the VR. | R | 00h |
| 11h | Status_2 | Data register showing optional status_2 data. | R | 00h |
| 12h | Temp zone | Data register showing temperature zones the system is operating in | R | 00h |
| 15h | I _{out} | 8 bit binary word ADC of current. This register reads 0xFF when the IOU(A) pin voltage is 2 V. The IOU(A) voltage should be scaled with an external resistor to ground such that a load equal to I _{cc} _Max generates a 2 V signal. | R | 01h |
| 16h | V _{out} | 8 bit binary word ADC of output voltage, measured between VSP and VSN. LSB size is 8 mV | R | 01h |
| 17h | VR_Temp | 8 bit binary word ADC of voltage. Binary format in deg C, IE 100C = 64h. A value of 00h indicates this function is not supported | R | 01h |

NCP6132A, NCP6132B

| Index | Name | Description | Access | Default |
|-------|--------------------|--|--------|---------|
| 18h | P_out | 8 bit binary word representative of output power. The output voltage is multiplied by the output current value and the result is stored in this register. A value of 00h indicates this function is not supported | R | 01h |
| 1Ch | Status 2 Last read | When the status 2 register is read its contents are copied into this register. The format is the same as the Status 2 Register. | R | 00h |
| 21h | Icc_Max | Data register containing the Icc_Max the platform supports. The value is measured on the ICCMAX pin on power up and placed in this register. From that point on the register is read only. | R | 00h |
| 22h | Temp_Max | Data register containing the max temperature the platform supports and the level VR_hot asserts. This value defaults to 100°C and programmable over the SVID Interface | R/W | 64h |
| 24h | SR_fast | Slew Rate for SetVID_fast commands. Binary format in mV/μs. | R | 0Ah |
| 25h | SR_slow | Slew Rate for SetVID_slow commands. It is 4X slower than the SR_fast rate. Binary format in mV/μs | R | 02h |
| 26h | Vboot | The NCP6132A/NCP6132B will ramp to Vboot and hold at Vboot until it receives a new SVID SetVID command to move to a different voltage. Default value = 0 V. | R | 00h |
| 30h | Vout_Max | Programmed by master and sets the maximum VID the VR will support. If a higher VID code is received, the VR should respond with "not supported" acknowledge. VR 12 VID format. | RW | FBh |
| 31h | VID setting | Data register containing currently programmed VID voltage. VID data format. | RW | 00h |
| 32h | Pwr State | Register containing the current programmed power state. | RW | 00h |
| 33h | Offset | Sets offset in VID steps added to the VID setting for voltage margining. Bit 7 is sign bit, 0 = positive margin, 1 = negative margin. Remaining 7 BITS are # VID steps for margin 2s complement. 00h = no margin 01h = +1 VID step 02h = +2 VID steps FFh = -1 VID step FEh = -2 VID steps. | RW | 00h |
| 34h | MultiVR Config | | | |

For NCP6132A/NCP6132B, VID code change is supported by SVID interface with three options as below:

| Option | SVID Command Code | Feature | Register Address (Indicating the slew rate of VID code change) |
|--------------|-------------------|---|---|
| SetVID_Fast | 01h | >10 mV/μs VID code change slew rate | 24h |
| SetVID_Slow | 02h | =1/4 of SetVID_Fast VID code change slew rate | 25h |
| SetVID_Decay | 03h | No slew rate control, VID code down | N/A |

Boot Voltage Programming

The NCP6132A/NCP6132B has a VBOOT voltage register that can be externally programmed for both core and aux boot-up output voltage. The VBOOT voltage can be programmed with a resistor from VBOOT pin to GND, or it can be set to 1.1 V by connecting VBOOT pin to GND to facilitate mass production. See the Boot Voltage Table.

BOOT VOLTAGE TABLE

| Boot Voltage (V) | Resistor Value (Ω) |
|------------------|--|
| 0 | 10k |
| 0.9 | 20k |
| 1.0 | 30k |
| 1.1 | 40k Or connect VBOOT pin to GND |
| 1.2 | 50k |
| 1.35 | 60k Or connect VBOOT pin to V _{CC} |

SVID Addressing

The NCP6132A/NCP6132B has fixed SVID device addresses for core and aux rail. The core rail address is 0000, and aux rail address is 0001.

Remote Sense Amplifier

A high performance high input impedance true differential amplifier is provided to accurately sense the output voltage of the regulator. The VSP and VSN inputs should be connected to the regulator’s output voltage sense points. The remote sense amplifier takes the difference of the output voltage with the DAC voltage and adds the droop voltage to

$$V_{DIFF} = (V_{VSP} - V_{VSN}) + (1.3\text{ V} - V_{DAC}) + (V_{DROOP} - V_{CSREF}) \quad (\text{eq. 1})$$

This signal then goes through a standard error compensation network and into the inverting input of the error amplifier. The non-inverting input of the error amplifier is connected to the same 1.3 V reference used for the differential sense amplifier output bias.

High Performance Voltage Error Amplifier

A high performance error amplifier is provided for high bandwidth transient performance. A standard type 3 compensation circuit is normally used to compensate the system.

Differential Current Feedback Amplifiers

Each phase has a low offset differential amplifier to sense that phase current for current balance and per phase OCP protection during soft-start. The inputs to the CSREF and CSPx pins are high impedance inputs. It is recommended that any external filter resistor RCSN not exceed 10 kΩ to avoid offset issues with leakage current. It is also recommended that the voltage sense element be no less than 0.5 mΩ for accurate current balance. Fine tuning of this time constant is generally not required.

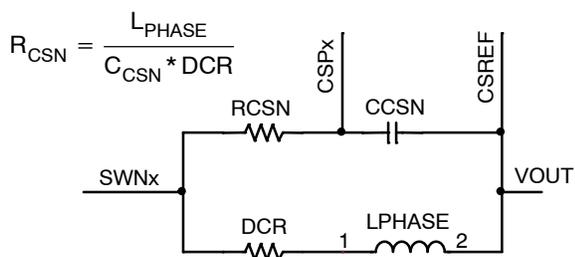


Figure 8.

The individual phase current is summed into to the PWM comparator feedback in this way current is balanced is via a current mode control approach.

Total Current Sense Amplifier

The NCP6132A/NCP6132B uses a patented approach to sum the phase currents into a single temperature

compensated total current signal. This signal is then used to generate the output voltage droop, total current limit, and the output current monitoring functions. The total current signal is floating with respect to CSREF. The current signal is the difference between CSCOMP and CSREF. The Ref(n) resistors sum the signals from the output side of the inductors to create a low impedance virtual ground. The amplifier actively filters and gains up the voltage applied across the inductors to recover the voltage drop across the inductor series resistance (DCR). Rth is placed near an inductor to sense the temperature of the inductor. This allows the filter time constant and gain to be a function of the Rth NTC resistor and compensate for the change in the DCR with temperature.

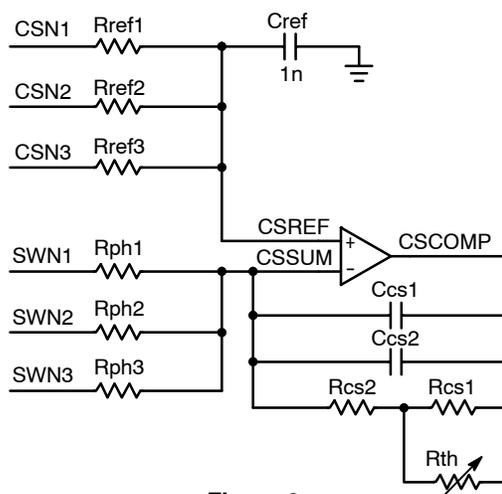


Figure 9.

The DC gain equation for the current sensing:

$$V_{CSCOMP-CSREF} = \frac{Rcs2 + \frac{Rcs1 \cdot Rth}{Rcs1 + Rth}}{Rph} * (I_{out_Total} * DCR) \quad (\text{eq. 2})$$

Set the gain by adjusting the value of the Rph resistors. The DC gain should set to the output voltage droop. If the voltage from CSCOMP to CSREF is less than 100 mV at ICCMAX then it is recommended to increase the gain of the CSCOMP amp and add a resistor divider to the Droop pin filter. This is required to provide a good current signal to offset voltage ratio for the ILIM pin. When no droop is needed, the gain of the amplifier should be set to provide ~100 mV across the current limit programming resistor at full load. The values of Rcs1 and Rcs2 are set based on the 220k NTC and the temperature effect of the inductor and should not need to be changed. The NTC should be placed near the closest inductor. The output voltage droop should be set with the droop filter divider.

The pole frequency in the CSCOMP filter should be set equal to the zero from the output inductor. This allows the circuit to recover the inductor DCR voltage drop current

signal. Ccs1 and Ccs2 are in parallel to allow for fine tuning of the time constant using commonly available values. It is best to fine tune this filter during transient testing.

$$F_Z = \frac{DCR@25^\circ C}{2 * \pi * L_{Phase}} \quad (eq. 3)$$

$$F_P = \frac{1}{2 * \pi * \left(R_{cs2} + \frac{R_{cs1} * R_{th}@25^\circ C}{R_{cs1} + R_{th}@25^\circ C} \right) * (C_{cs1} + C_{cs2})} \quad (eq. 4)$$

Programming the Current Limit

The current-limit thresholds are programmed with a resistor between the ILIM and CSCOMP pins. The ILIM pin mirrors the voltage at the CSREF pin and mirrors the sink current internally to IOUT (reduced by the IOUT Current Gain) and the current limit comparators. Set the value of the current limit resistor based on the user-set output current limit Iout_LIMIT or CSREF- CSCOMP voltage at Iout_LIMIT condition as shown below:

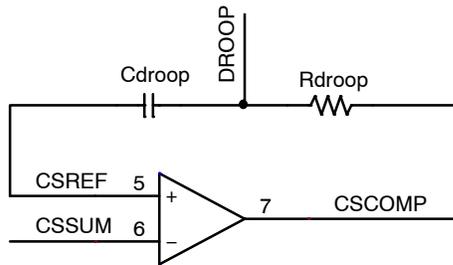
$$R_{ILIM} = \frac{R_{cs2} + \frac{R_{cs1} * R_{th}}{R_{cs1} + R_{th}} * (I_{out_LIMIT} * DCR)}{10 \mu A} \quad (eq. 5)$$

or

$$R_{ILIM} = \frac{V_{CSREF-CSCOMP@ILIMIT}}{10 \mu A} \quad (eq. 6)$$

Programming DROOP and DAC Feed-Forward Filter

The signals DROOP and CSREF are differentially summed with the output voltage feedback to add precision voltage droop to the output voltage. The total current feedback should be filtered before it is applied to the DROOP pin. This filter impedance provides DAC feed-forward during dynamic VID changes. Programming this filter can be made simpler if CSCOMP-CSREF is equal to the droop voltage. Rdroop sets the gain of the DAC feed-forward and Cdloop provides the time constant to cancel the time constant of the system per the following equations. Cout is the total output capacitance and Rout is the output impedance of the system.



$$R_{droop} = C_{out} * R_{out} * 453.6 \times 10^6$$

$$C_{droop} = \frac{R_{out} * C_{out}}{R_{droop}}$$

Figure 10.

If the Droop at maximum load is less than 100 mV at ICCMAX we recommend altering this filter into a voltage divider such that a larger signal can be provided to the ILIM resistor by increasing the CSCOMP amp gain for better current monitor accuracy. The DROOP pin divider gain should be set to provide a voltage from DROOP to CSREF equal to the amount of voltage droop desired in the output. A current is applied to the DROOP pin during dynamic VID. In this case Rdloop1 in parallel with Rdloop2 should be equal to Rdloop.

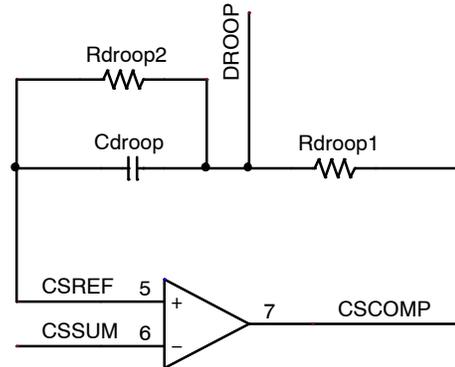


Figure 11.

Programming IOUT

The IOUT pin sources a current equal to the ILIM sink current gained by the IOUT Current Gain. The voltage on the IOUT pin is monitored by the internal A/D converter and should be scaled with an external resistor to ground such that a load equal to ICCMAX generates a 2 V signal on IOUT. A pull-up resistor from 5 V VCC can be used to offset the IOUT signal positive if needed.

$$R_{IOUT} = \frac{2.0 V * R_{LIMIT}}{10 * \left(R_{cs2} + \frac{R_{cs1} * R_{th}}{R_{cs1} + R_{th}} * (I_{out_ICC_MAX} * DCR) \right)} \quad (eq. 7)$$

Programming ICC_MAX and ICC_MAXA

The SVID interface provides the platform ICC_MAX value at register 21h for both the core and the aux rails. A resistor to ground on the PWM and PWMA pins program these registers at the time the part is enabled. 10 μA is sourced from these pins to generate a voltage on the program resistor. The value of the register is 1 A per LSB. When ICC_MAX is less than 118 A, resistor value is set according to the equation below. The resistor value should be no less than 10 k.

$$R_{ICC_MAX} = \frac{ICC_MAX_{21h} * 2 V}{10 \mu A * 256 A} + 3.5 k\Omega \quad (eq. 8)$$

Programming TSNS and TSNSA

Two temperature sense inputs are provided. A precision current is sourced out the output of the TSNS and TSNSA

pins to generate a voltage on the temperature sense network. The voltages on the temperature sense inputs are sampled by the internal A/D converter and then digitally converted to temperature and stored in SVID register 17h. A 100 k NTC should be used. The Rcomp1 and Rcomp2 vary with NTC's temperature characteristics.

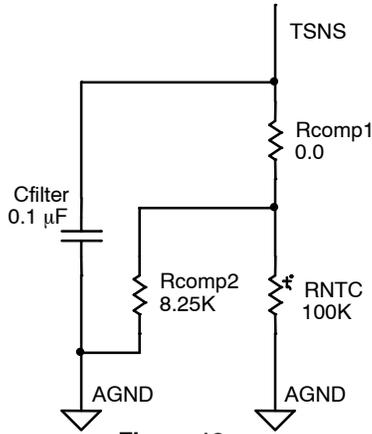


Figure 12.

Precision Oscillator

A programmable precision oscillator is provided. The clock oscillator serves as the master clock to the ramp generator circuit. This oscillator is programmed by a resistor to ground on the ROSC pin. The ROSC pin provides approximately 2 V out and the source current is mirrored into the internal ramp oscillator. The oscillator generates triangle ramps that are 0.5 ~ 2.5 V in amplitude depending on the VRMP pin voltage to provide input voltage feed forward compensation. The oscillator frequency is approximately proportional to the current flowing in the ROSC resistor.

$$f_{OSC} = \frac{1}{2 \left(\frac{V_{OSC}}{V_{ref}} R_{OSC} C_{OSC} + 2t_d \right)} \quad (eq. 9)$$

Where

- f_{OSC} PWM master oscillator frequency
- V_{OSC} oscillator ramp peak-to-peak voltage (1 V)
- V_{ref} ROSC pin reference voltage (2 V)
- R_{OSC} ROSC pin frequency setting resistor
- C_{OSC} oscillator timing capacitor (2.5 pF)
- t_d oscillator loop delay (10 ns)

And the per phase switching frequency f_{sw} is given by

$$f_{sw} = \frac{f_{OSC}}{12} \quad (eq. 10)$$

The switching frequency range is between 200 kHz/phase to 800 kHz/phase.

Programming the Ramp Feed-Forward Circuit

The ramp generator circuit provides the ramp used by the PWM comparators. The ramp generator provides voltage feed-forward control by varying the ramp magnitude with respect to the VRMP pin voltage. The VRMP pin also has a 4 V UVLO function. The VRMP UVLO is only active after the controller is enabled. The VRMP pin is a high impedance input when the controller is disabled.

The PWM ramp time is changed according to the following,

$$V_{RAMPpk=pk_{pp}} = 0.1 * V_{VRMP} \quad (eq. 11)$$

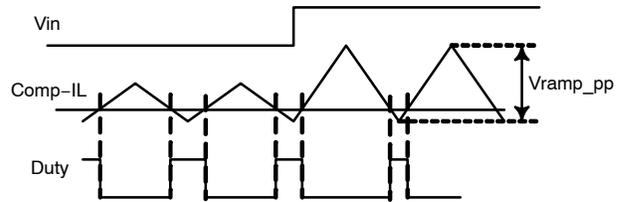


Figure 13.

Programming TRBST#

The TRBST# pin provides a signal to offset the output after load release overshoot. This network should be fine tuned during the board tuning process and is only necessary in systems with significant load release overshoot. The TRBST# network allows maximum boost for low frequency load release events to minimize load release ringing back undershoot. The network time constants are set up to provide a TRBST# roll of at higher frequencies where it is not needed. Cboost1 * Rbst1 controls the time constant of the load release boost. This should be set to counter the under shoot after load release. Rbst1 + Rbst2 controls the maximum amount of boost during rapid step loading. Rbst2 is generally much larger than Rbst1. The Cboost2 * Rbst2 time constant controls the roll off frequency of the TRBST# function.

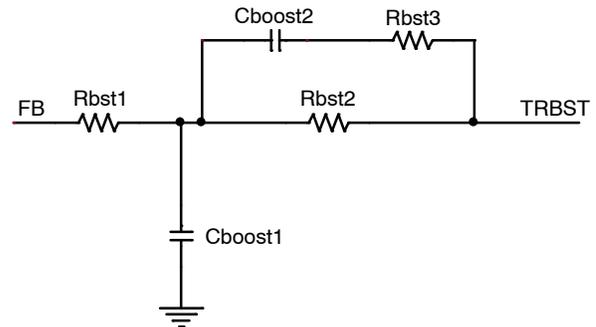


Figure 14.

PWM Comparators

During steady state operation, the duty cycle is centered on the valley of the triangle ramp waveform and both edges of the PWM signal are modulated. During a transient event

the duty will increase rapidly and proportionally turning on all phases as the error amp signal increases with respect to the ramps to provide a highly linear and proportional response to the step load.

PROTECTION FEATURES

Input Under Voltage Protection

NCP6132A/NCP6132B monitors the 5 V VCC supply and the VRMP pin for under voltage protection. The gate driver monitors both the gate driver VCC and the BST voltage. When the voltage on the gate driver is insufficient it will pull HG1, HG2, HGA, LG1, LG2, LGA, DRVEN low and notify the controller the power is not ready. The gate driver will hold HG1, HG2, HGA, LG1, LG2, LGA, DRVEN low for a minimum period of time to allow the controller to restart its startup sequence. In this case the PWM and PWMA are set back to the MID state and soft start would begin again. See the figure below.

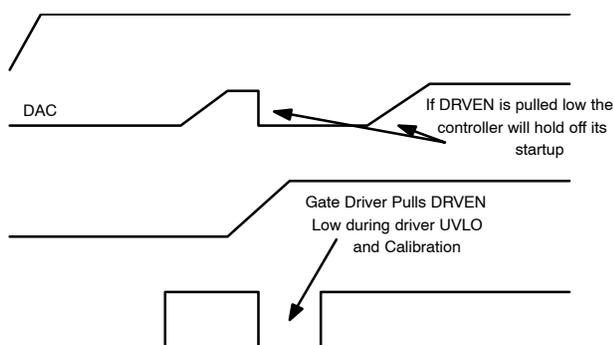


Figure 15. Gate Driver UVLO Restart

Soft Start

Soft start is implemented internally. A digital counter steps the DAC up from zero to the target voltage based on the predetermined slew rate in the spec table. The PWM signals will start out open with a test current to collect data on IMAX/IMAXA and for setting internal registers. After the IMAX/IMAXA configuration data is collected the controller enables and sets the PWM signal to the 2.0 V MID state to indicate that the drivers should be in diode mode. DRVEN will then be asserted and the COMP pin released to begin soft-start. The DAC will ramp from Zero to the target DAC codes and the PWM outputs will begin to fire. Each phase will move out of the MID state when the first PWM pulse is produced preventing the discharge of a pre-charged output.

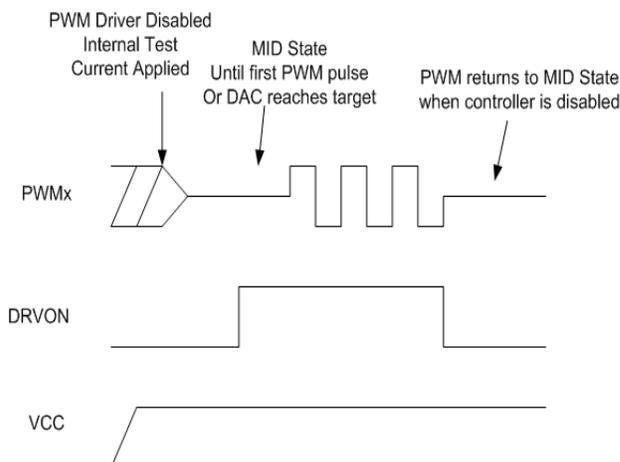


Figure 16. Soft-Start Sequence

Over Current Latch- Off Protection

The NCP6132A/NCP6132B provides two different types of current limit protection. During normal operation a programmable total current limit is provided that scales with the phase count during power saving operation. A second fixed per-phase current limit is provided for VID lower than 0.25 V, such as during soft-start.

The level of total current limit is set with the resistor from the ILIM pin to CSCOMP pin. Internally the current through ILIM pin is scaled and then compared to two current thresholds 10 μ A and 15 μ A, where 10 μ A threshold is scaled to indicate the 100% current limit and 15 μ A indicates the 150% current limit. If 100% current limit is exceeded, an internal latch-off counter starts. The controller shuts down if the over current fault is not removed after 50 μ s. If 150% current limit is exceeded, the controller shuts down immediately. To recover from an OCP fault the EN pin must be cycled low. The current limit is scaled down along with the phase shedding. Phase shedding from 3-phase to single phase scales the current limit to its 1/3; phase shedding from 2-phase to single phase scales the current limit to its half. For example, for a 3-phase design in PS0 state the 100% current limit trips if ILIM current exceeds 10 μ A, but in PS1/2/3 state (phase shedding to single phase) ILIM current above 3.3 μ A will trigger the 100% current limit.

Under Voltage Monitor

The output voltage is monitored at the output of the differential amplifier for UVLO. If the output falls more than 300 mV below the DAC-DROOP voltage the UVLO comparator will trip sending the VRDY/VRDYA signal low.

Over Voltage Protection

During normal operation the output voltage is monitored at the differential inputs VSP and VSN. If the output voltage exceeds the DAC voltage by approximately 250 mV, LGx from integrated drivers will be forced high and PWM/PWMA will be forced low when OVP is triggered. And then the DAC will ramp down to zero to avoid a negative output voltage spike during shutdown. When the DAC gets to zero, LGx will be forced high and PWM/PWMA will be forced low with DRVEN remaining high. To reset the part the EN pin must be cycled low.

During soft-start & DVID, the OVP has a fix threshold at 1.75 V.

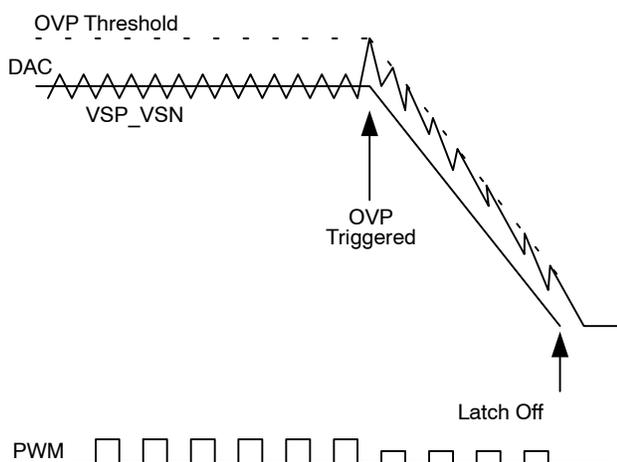


Figure 17. OVP Threshold Behavior

Layout Notes

The NCP6132A/NCP6132B has differential voltage and current monitoring. This improves signal integrity and reduces noise issues related to layout for easy design use. To insure proper function there are some general rules to follow:

Careful layout in per phase and total current sensing are critical for jitter minimization, accurate current balancing and ILIM and IOULT monitoring. Give the first priority in component placement and trace routing to per phase and total current sensing circuit. The per phase inductor current sense RC filters should always be placed as close to the CSREF and CSP pins on the controller as possible. The filter cap from CSCOMP to CSREF should also be close to the controller. The temperature-compensate resistor R_{TH} should be placed as close as possible to the Phase 1 inductor. The wiring path between R_{CSx} and R_{PHx} should be kept as short as possible and well away from switch node lines. The Refx resistors (10 Ω) connected to CSREF pin should be placed near the inductors to reduce the length of traces. The resistors R_{PHx} are better to have 0603 package. The above layout notes are shown in Figure 18.

Place the V_{CC} decoupling caps as close as possible to the controller VCC pin. For any RC filter on the VCC and VDDBP pins, the resistor should be no higher than 2.2 Ω to prevent large voltage drop.

The small high feed back cap from COMP to FB should be as close to the controller as possible. Keep the FB traces short to minimize their capacitance to ground.

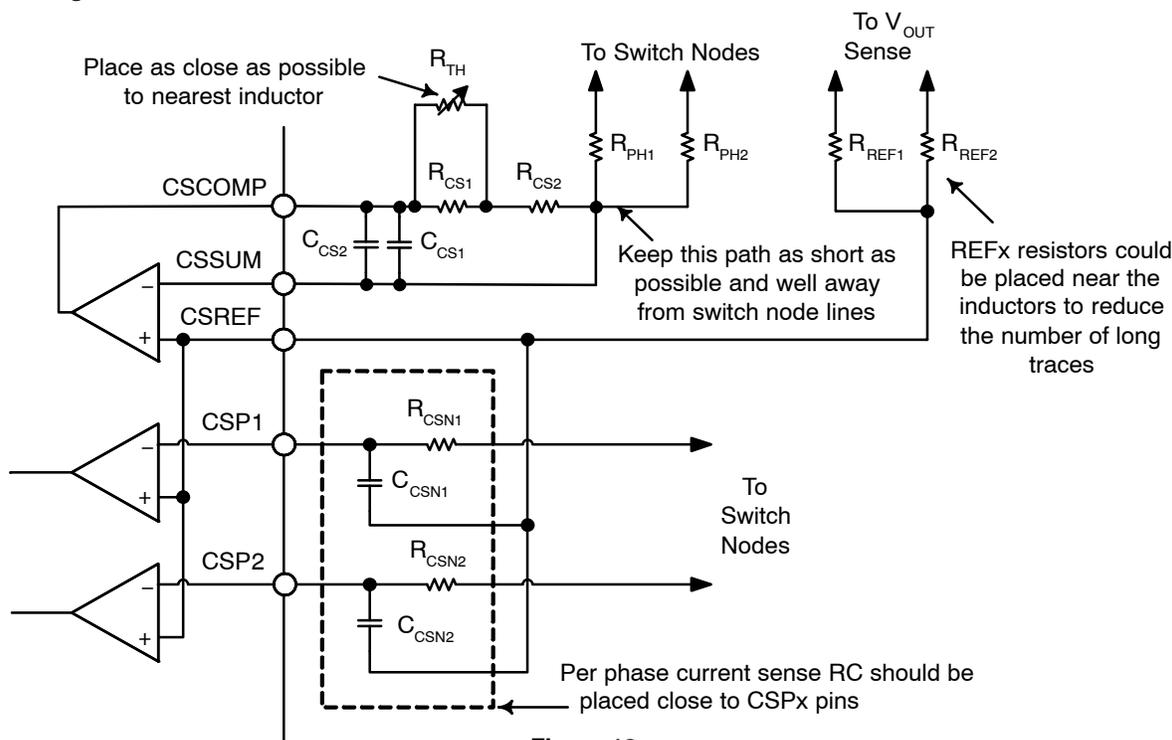
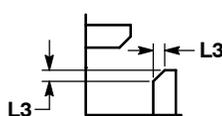
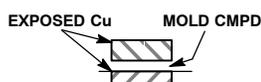
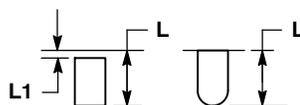
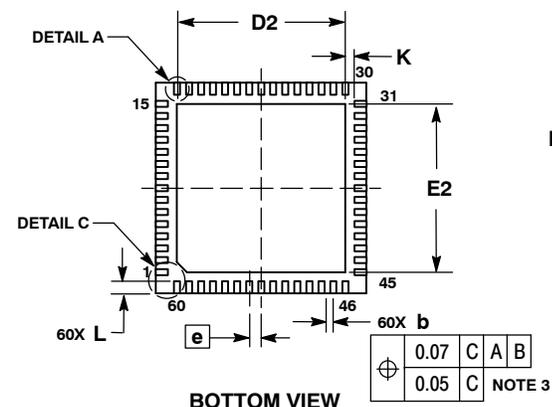
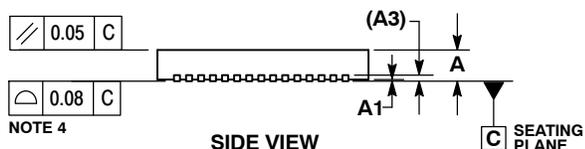
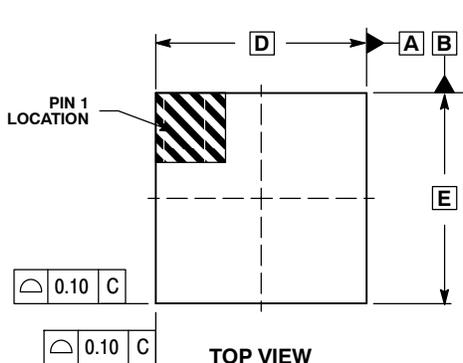


Figure 18.

NCP6132A, NCP6132B

PACKAGE DIMENSIONS

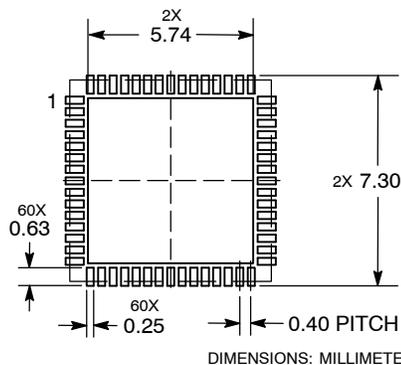
QFN60 7x7, 0.4P
CASE 485BB
ISSUE A



- NOTES:
1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO THE PLATED TERMINAL AND IS MEASURED ABETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 | REF |
| b | 0.15 | 0.25 |
| D | 7.00 | BSC |
| D2 | 5.50 | 5.70 |
| E | 7.00 | BSC |
| E2 | 5.50 | 5.70 |
| e | 0.40 | BSC |
| K | 0.30 | REF |
| L | 0.30 | 0.50 |
| L1 | --- | 0.15 |
| L3 | 0.10 | REF |

RECOMMENDED SOLDERING FOOTPRINT*



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